# **DZ2S360**

## Silicon epitaxial planar type

For constant voltage / waveform clipper and surge absorption circuit Low noise type DZ2J360 in SSMini2 package

#### DZZ0000 III COMIIIIZ packago

#### ■ Features

- Excellent rising characteristics of zener current I<sub>z</sub>
- Eco-friendly Halogen-free package

#### Packaging

Embossed type (Thermo-compression sealing): 3000 pcs / reel (standard)

### ■ Absolute Maximum Ratings $T_a = 25$ °C

Parameter	Symbol	Rating	Unit
Repetitive peak forward current	$I_{FRM}$	200	mA
Total power dissipation *	P <sub>T</sub>	150	mW
Junction temperature	T <sub>j</sub>	150	°C
Storage temperature	T <sub>stg</sub>	-55 to +150	°C

Note) \*: P<sub>T</sub> = 150 mW achieved with a printed circuit board.

#### ■ Package

Code

SSMini2-F5-B

- Pin Name
  - 1. Cathode
  - 2. Anode
- Marking Symbol: JG, JR

### ■ Common Electrical Characteristics $T_a = 25$ °C±3°C

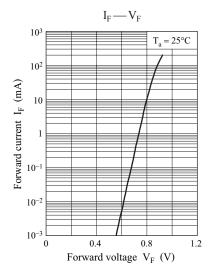
Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Forward voltage	$V_{\mathrm{F}}$	$I_F = 10 \text{ mA}$			1.0	V
Zener voltage *1, 2, 4	V <sub>Z</sub>	$I_Z = 2 \text{ mA}$	34.20		37.80	V
Zener operating resistance	$R_Z$	$I_Z = 2 \text{ mA}$			250	Ω
Zener rise operating resistance	R <sub>ZK</sub>	$I_Z = 0.5 \text{ mA}$			250	Ω
Reverse current	$I_R$	$V_R = 27 V$			0.05	μΑ
Temperature coefficient of zener voltage *3	$S_Z$	$I_Z = 2 \text{ mA}$		35.4		mV/°C

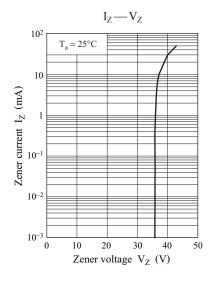
Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7031 measuring methods for diodes.

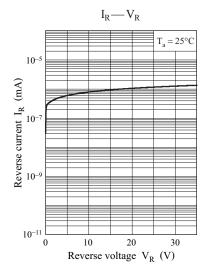
- 2. Absolute frequency of input and output is 5 MHz.
- 3. \*1: The temperature must be controlled 25°C for  $V_Z$  measurement.  $V_Z$  value measured at other temperature must be adjusted to  $V_Z$  (25°C)
  - $*2: V_Z$  guaranteed 20 ms after current flow.
  - \*3:  $T_j = 25^{\circ}C$  to  $150^{\circ}C$
  - \*4: Rank classification

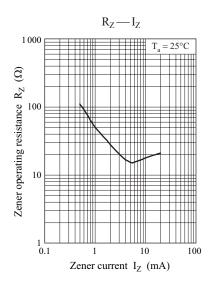
Code	M	0	
Rank	М	No-rank	
$V_{Z}$	35.10 to 36.90	34.20 to 37.80	
Marking Symbol	JR	JG	

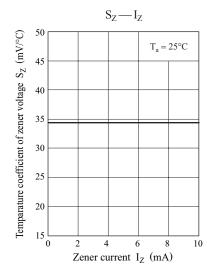
DZ2S360 Panasonic

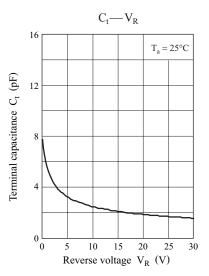








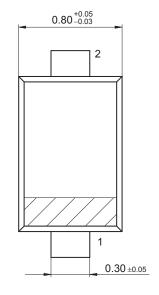


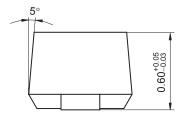


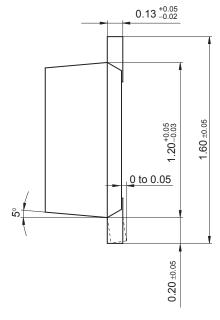
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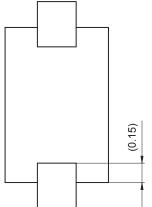
# SSMini2-F5-B

Unit: mm









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